



CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Features

- High isolation 5000 VRMS
- Supports 0.3 A, 0.6 A, 0.9 A and 1.2 A
- RoHS compliant
- REACH compliance
- External creepage > 7.5mm
- Internal creepage > 6.0mm
- Insulation distance > 0.4mm
- Regulatory Approvals
 - UL - UL1577 (pending approval)
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC – GB4943.1, GB8898
 - IEC60065, IEC60950

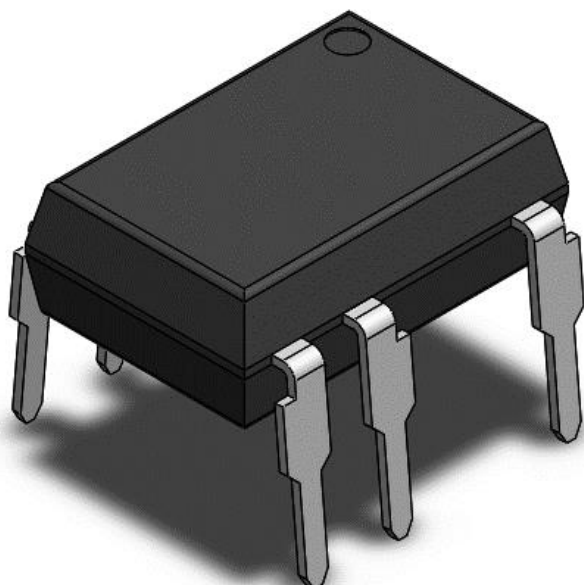
Description

The zero crossing power Triac consists of a Triac and a photo-Triac, which is optically coupled to a gallium arsenide Infrared emitting diode, and house in a 7-lead DIP package. It also comes with different lead forming options.

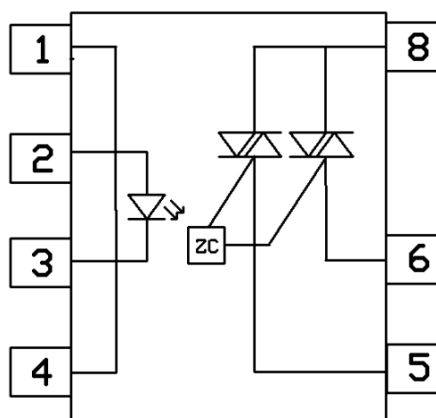
Applications

- Home appliances
- Industrial equipment

Package Outline



Schematic



Note: Different bending options available. See package dimension.



CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Absolute Maximum Rating at 25°C

Symbol	Parameters		Ratings	Units	Notes
V _{iso}	Isolation voltage		5000	V _{rms}	
T _{OPR}	Operating temperature		-40 ~+85	°C	
T _{STG}	Storage temperature		-40 ~+125	°C	
T _{SOL}	Soldering temperature		260	°C	
	Wave soldering temperature		260	°C	
Emitter					
I _F	LED forward current		50	mA	
V _R	LED reverse voltage		6	V	
I _{FP}	Peak forward current		1	A	
P _{In}	Power dissipation		75	mW	
Detector					
V _{DRM}	Repetitive peak OFF-state voltage		600	V	
I _{T(RMS)}	Continuous Current Load	CTT02XX	0.3	A	
		CTT12XX	0.6		
		CTT22XX	0.9		
		CTT32XX	1.2		
I _{TSM}	Peak Current Load	CTT02XX	3	A	
		CTT12XX	6		
		CTT22XX	9		
		CTT32XX	12		
P _{out}	Power dissipation		800	mW	
P _T	Total power dissipation		850	mW	



CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Electrical Characteristics $T_A = 25^\circ\text{C}$ (unless otherwise specified)

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
V_F	Forward voltage	$I_F = 10\text{mA}$	-	-	1.3	V	
I_R	Reverse Current	$V_R = 6\text{V}$	-	-	5	μA	
C_{IN}	Input Capacitance	$f = 1\text{MHz}$	-	45	-	pF	

Detector Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
I_{DRM1}	Peak Blocking Current	$I_F = 0\text{mA}$, $V_{DRM} = 600\text{V}$	-	-	100	μA	
I_{DRM2}	Inhibit Leakage Current	$I_F = \text{Rated } I_{FT}$, $V_{DRM} = 600\text{V}$			500	μA	
V_{INH}	Inhibit Voltage	$I_F = \text{Rated } I_{FT}$	-	-	50	V	
V_{TM}	Peak On-State Voltage	$I_F = \text{Rated } I_{FT}$, $I_{TM} = 100\text{mA}$	-	-	2.5	V	
dv/dt	Critical Rate of Rise off-State Voltage	$V_{PEAK} = \text{Rated } V_{DRM}$	200	-	-	$\text{V}/\mu\text{s}$	

Transfer Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
I_{FT}	Input Trigger Current	Terminal Voltage = 3V	-	-	10	mA	
I_H	Holding Current		-	-	25	mA	
R_{IO}	Isolation Resistance	$V_{IO} = 500\text{V}_{DC}$	1×10^{11}	-	-	Ω	
C_{IO}	Isolation Capacitance	$f = 1\text{MHz}$	-	0.25	-	pF	



CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Typical Characteristic Curves

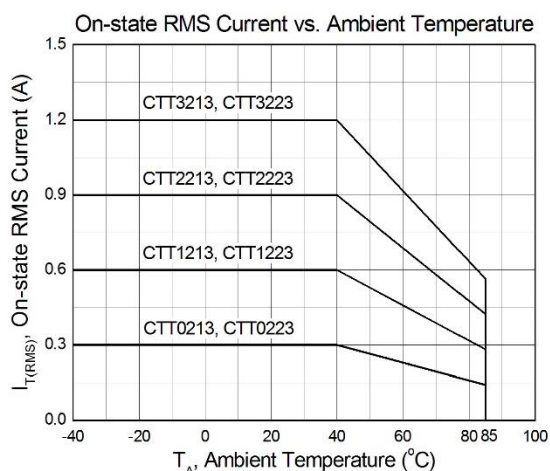


Figure 1

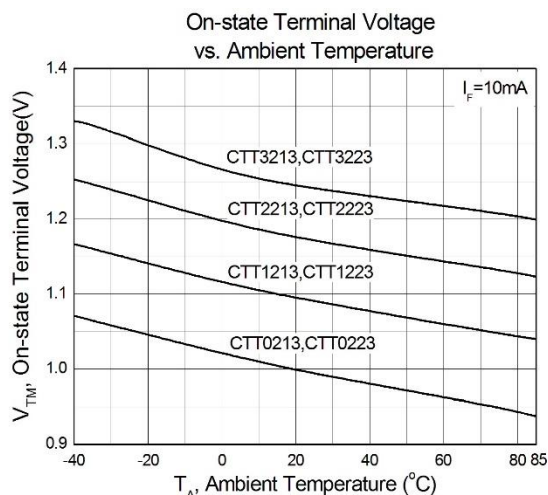


Figure 2

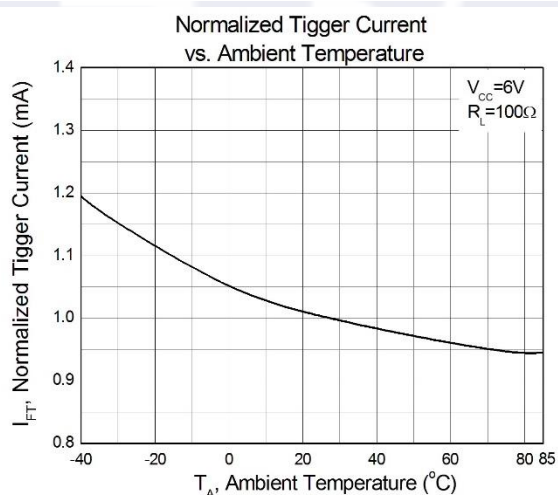


Figure 3

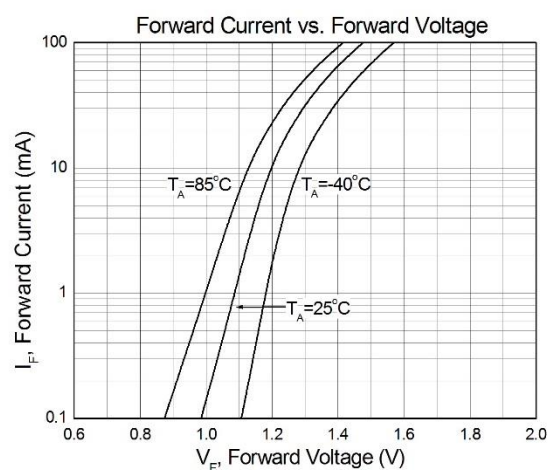


Figure 4

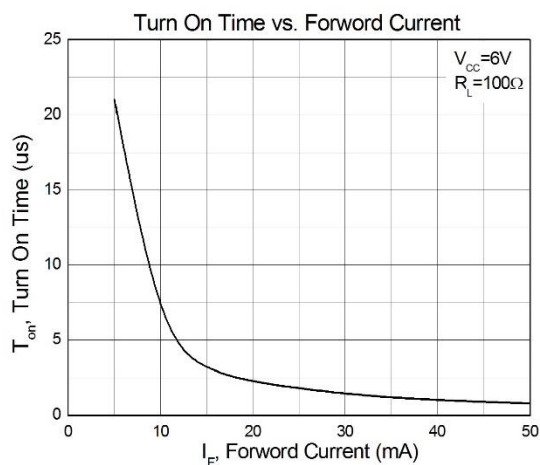


Figure 5

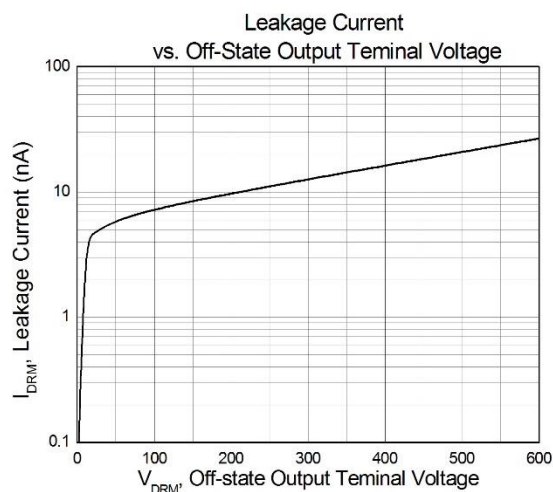


Figure 6



CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Typical Characteristic Curves

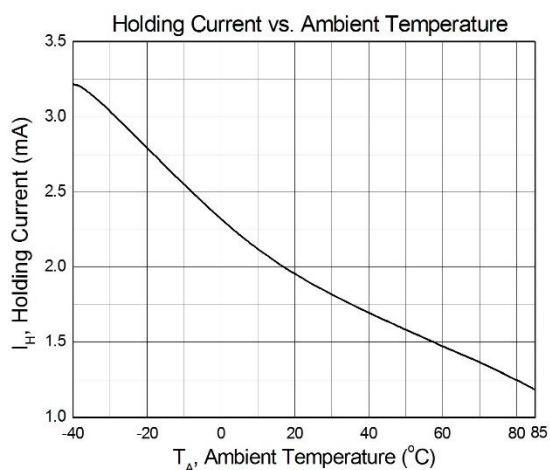


Figure 7

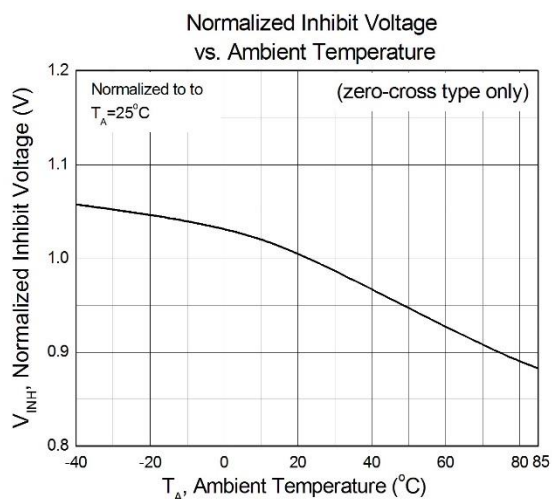


Figure 8

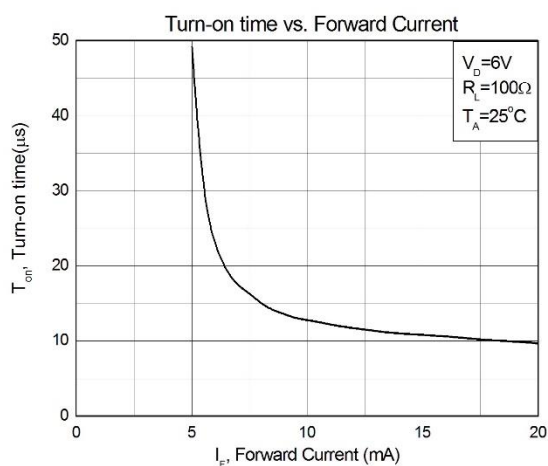


Figure 9

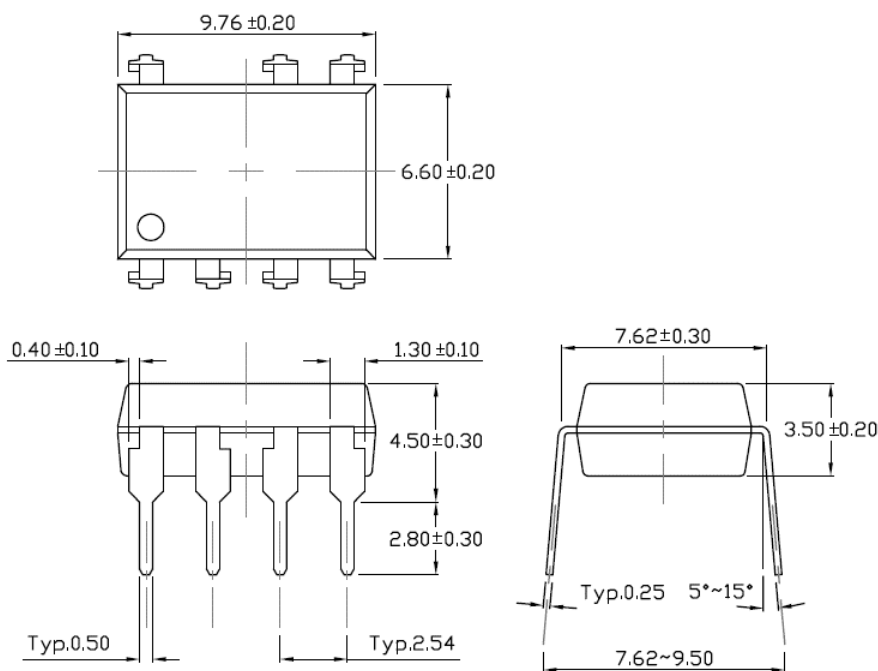


CTT0213, CTT1213, CTT2213, CTT3213

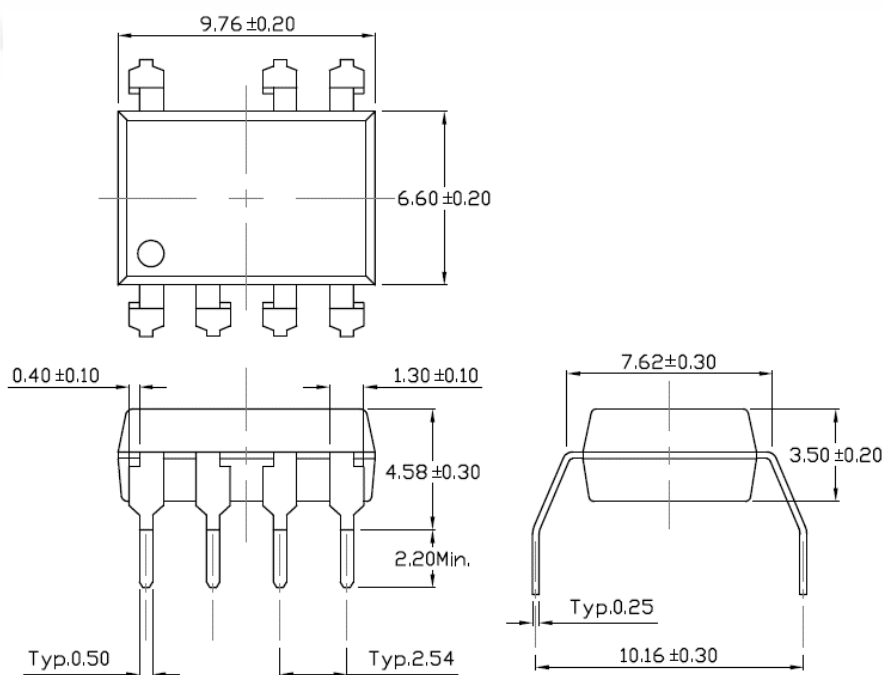
600V Zero Cross High Power Photo TRIAC

Package Dimension *Dimensions in mm unless otherwise stated*

Standard DIP – Through Hole



Gullwing (400mil) Lead Forming – Through Hole (M Type)

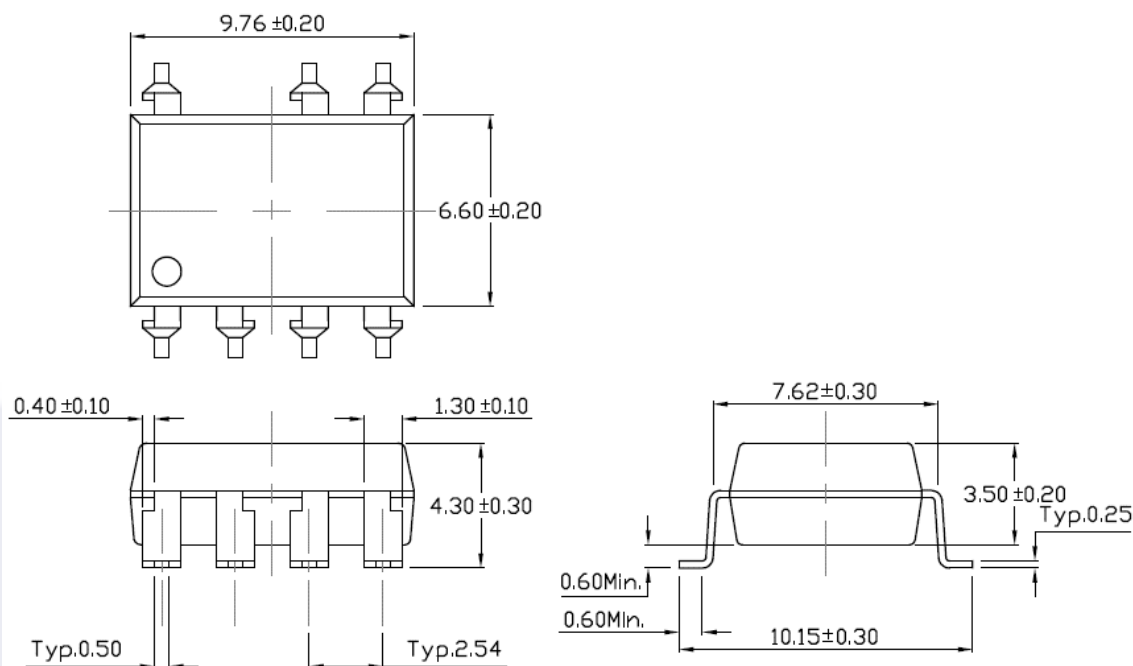




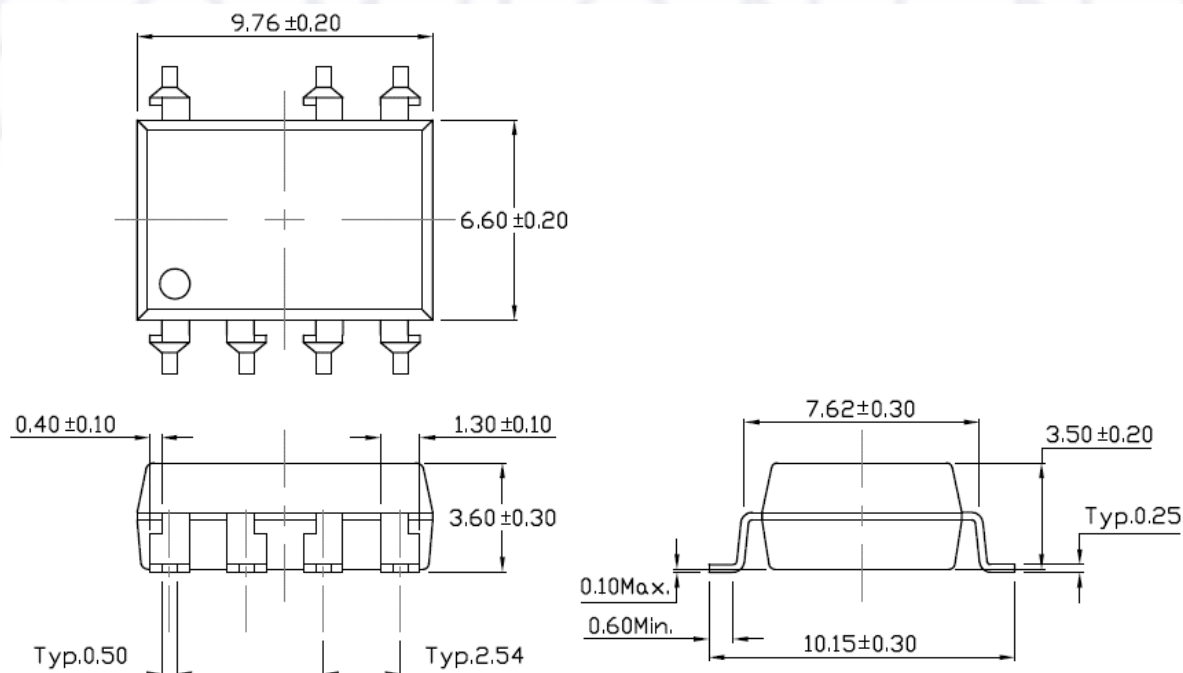
CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Surface Mount Lead Forming (S Type)



Surface Mount (Low Profile) Lead Forming (SL Type)

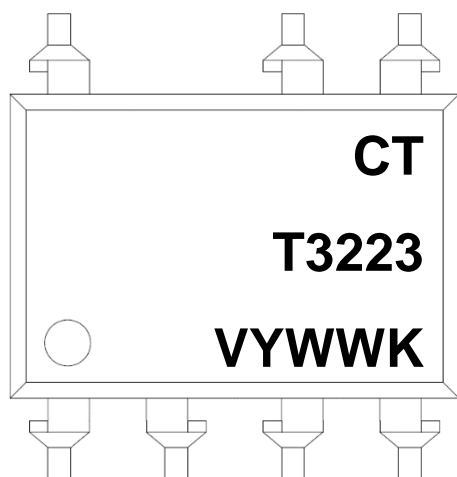




CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Device Marking



Note:

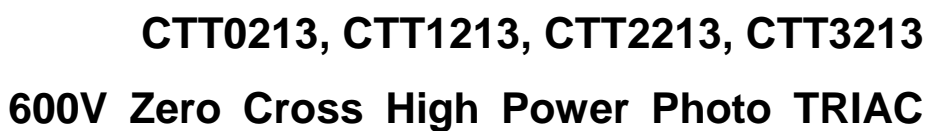
CT : Denotes "CT Micro"
T3223 : Product Number
V : VDE Safety Mark (option)
Y : Fiscal Year
WW : Work Week
K : Production Code

Ordering Information

CTTX2XX(V)(Y)(Z)

CT = Denotes "CT Micro"
TX2XX = Product Number (Current Rating Option X=0, 1, 2, or 3)
V = VDE safety mark option (V, or none)
Y = Lead form option (S, SL, M or none)
Z = Tape and reel option (T1, T2 or none)

Option	Description	Quantity
None	Standard 8 Pin Dip	40 Units/Tube
M	Gullwing (400mil) Lead Forming	40 Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming– With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming– With Option 2 Taping	1000 Units/Reel





CTT0213, CTT1213, CTT2213, CTT3213 600V Zero Cross High Power Photo TRIAC

Wave soldering (JEDEC22A111 compliant)

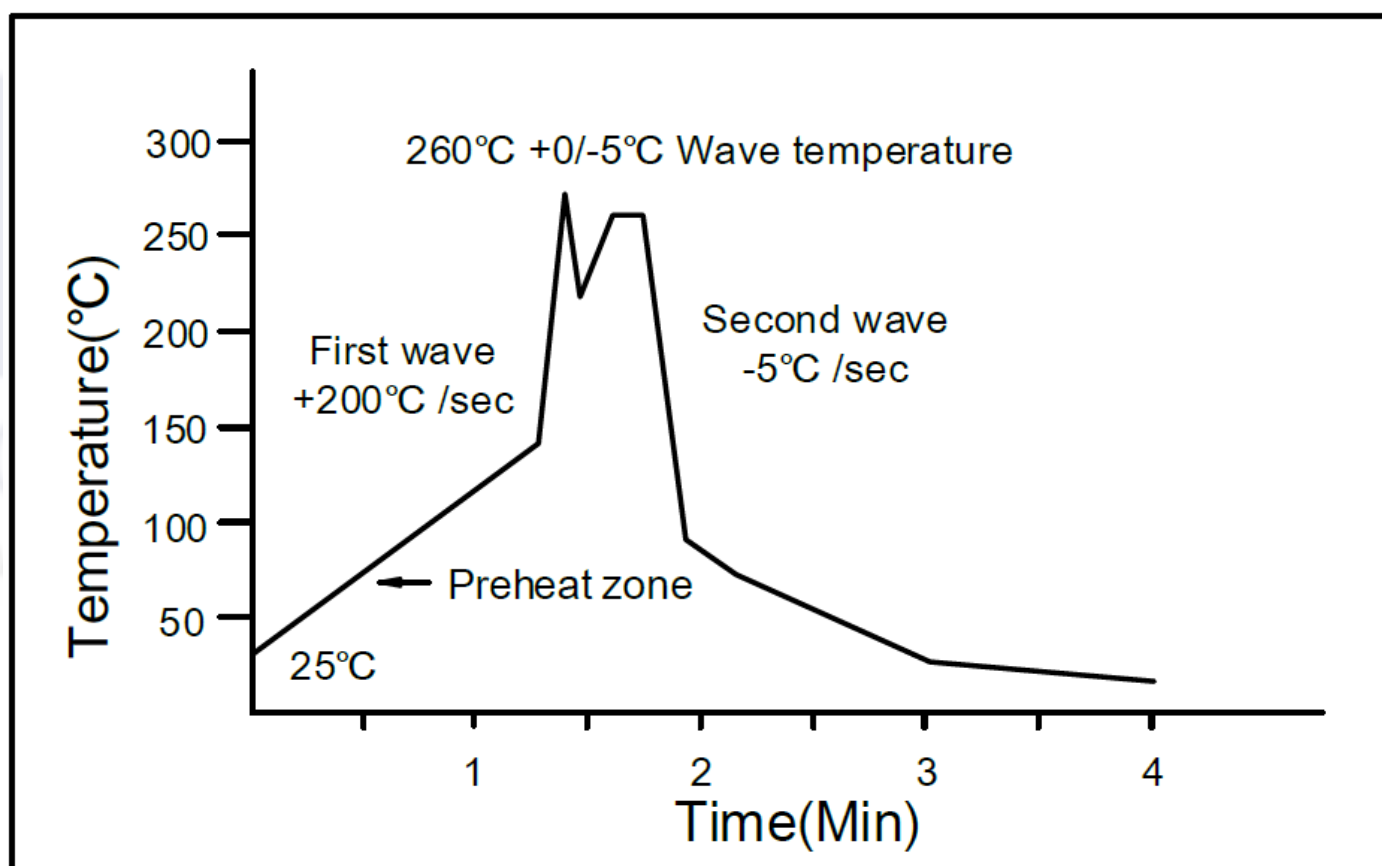
One time soldering is recommended within the condition of temperature.

Temperature: $260 \pm 5^\circ\text{C}$.

Time: 10 sec.

Preheat temperature: 25 to 140°C .

Preheat time: 30 to 80 sec.



Hand soldering by soldering iron

Allow single lead soldering in every single process.

One time soldering is recommended. Temperature: $350 \pm 5^\circ\text{C}$

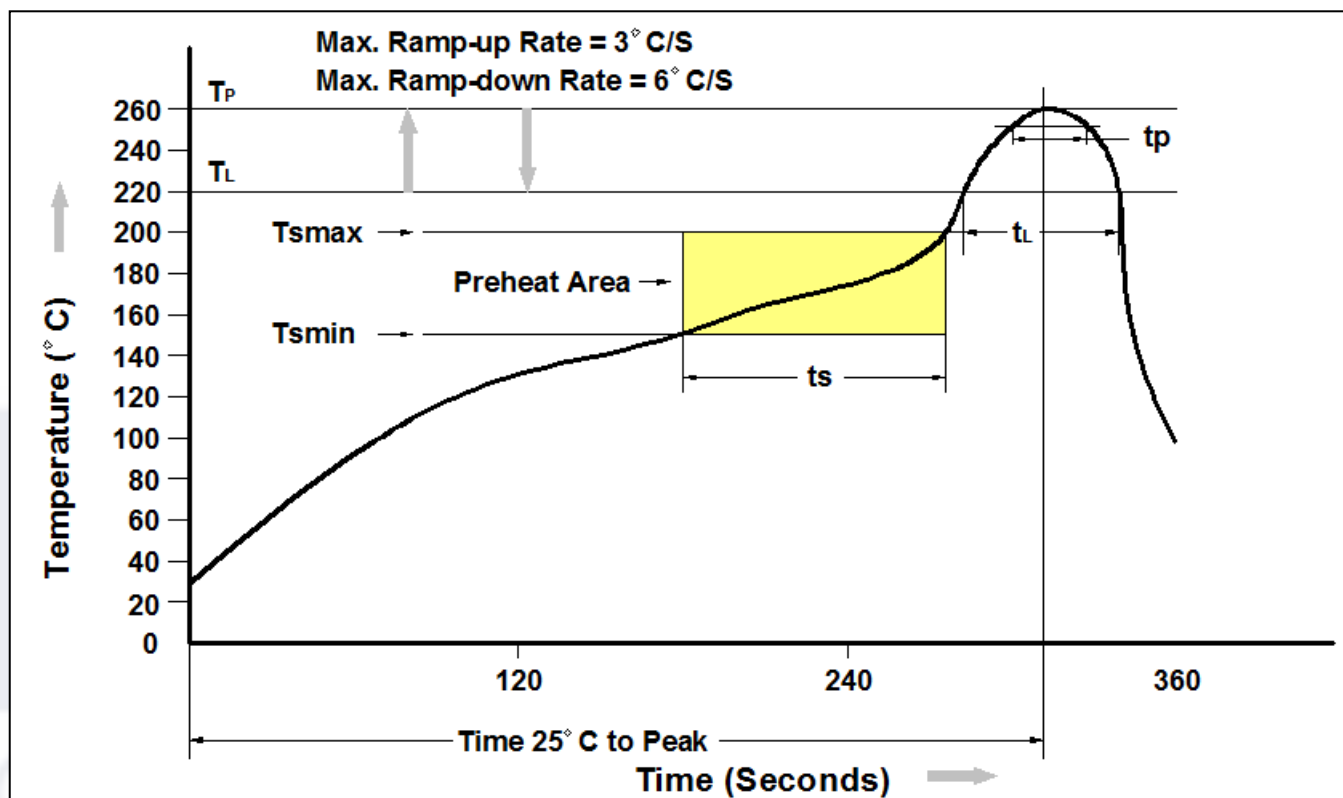
Time: 3 sec max.



CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



CTT0213, CTT1213, CTT2213, CTT3213

600V Zero Cross High Power Photo TRIAC

DISCLAIMER

CT MICRO RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. CT MICRO DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

CT MICRO ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT EXPRESS WRITTEN APPROVAL OF CT MICRO INTERNATIONAL CORPORATION.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instruction for use provided in the labelling, can be reasonably expected to result in significant injury to the user.*
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.*